

Strategy for Automotive Market

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Key Applications - Automotive Market



3 Megatrends: Demand Outlook

Demand for TDK products (exclude batteries)

Fuel Efficiency

Applications

xEV

(electrics, hybrids, fuel cells)
48V System
Engine Control Unit
Idling Stop
Transmission

Safety

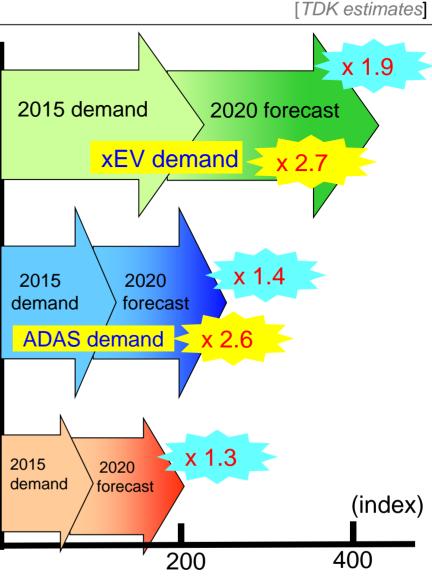
ADAS

(Advanced Driver Assistance Systems)
Brake systems (ABS, etc.)
Airbags
TPMS

Comfort & Connectivity

V2X

In-Vehicle Infotainment
Emergency communication
(e-Call)
Keyless Entry
LED headlamps
Electric Park Brake (EPB)



Strategic TDK Products for Automotive Applications **ATDK**



Fuel Efficiency



Strategic Products	Features
DC/DC converters & key components	* Miniaturized to provide space-saving advantage to auto makers. * Further reduction in size and higher efficiency achieved through new materials (e.g. GaN, new magnetic materials).
On-board chargers	* Demand surging with the increase of EV/PHEV DC/DC converter technologies are utilized to make the chargers smaller, lighter and more efficient.
Magnets	* Neodymium magnets: saves energy/electricity when used in EV drive motor. Dy (dysprosium)-free, and rare earth-free magnets are being developed. * Ferrite magnets: Allows DC motors to be highly efficient yet smaller in size. We now have La (lanthanum)-free and Co (cobalt)-free types.
TMR sensors	* TMR enhances high-precision control in EPS, thus answering the need for improved fuel efficiency. * TMR allows for higher sensitivity and stable accuracy operation in a wider range of temperature (sensitivity vs. AMR = x30; vs. GMR= x8).
Wireless charging system	* By 2022, 10% of EV/PHEV will be equipped with wireless charging system (TDK estimate: 300-500 thousand vehicles). * Magnetic resonance coupling and magnetic technologies will assure highly efficient wireless

power transfer.

Strategic TDK Products for Automotive Applications **ATDK**



Safety

Comfort & Connectivity

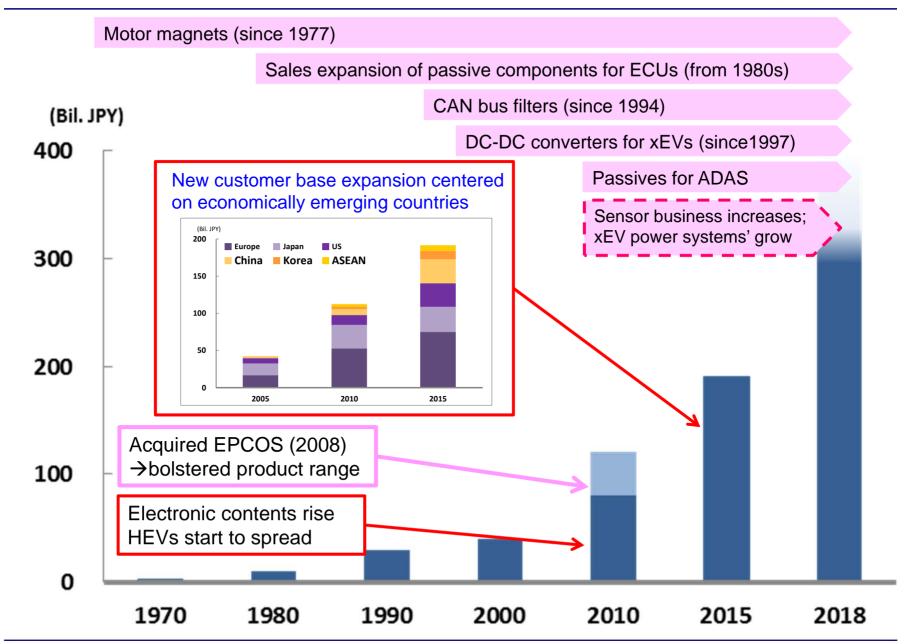


Strategic Products	Features
Common mode filters for CAN-BUS / FlexRay, Ethernet	* High reliability design for automotive use; wide frequency range common mode impedance effective for extended output characteristics that differ with each IC model.
MLCCs 第二個	* High-rel. auto grade series, guaranteed for high temp. (150°C): high capacitance, mid-voltage, mega-caps, and soft termination capacitors.
Inductors High temp. (150°C) power inductors antenna coils	* High-efficiency/high-reliability power inductors designed for performance in the grueling conditions of the engine compartment (-55°C ~ +150°C). * Antenna coils for use in wireless devices - smart keys, TPMS (tire pressure monitoring system), etc are now being mass produced.
SAW devices / thin film high freq. filters Bluetooth® modules	Communication products have been further developed for automotive applications such as keyless entry and telematics.
Sensors Magnetic, pressure, current, temperature, light, etc.	Sensors are adapted for automotive use: TMR sensors are used for angle, position, rotation and current sensing applications.

Get products on automotive IC reference designs through close collaboration with IC makers.

TDK Sales Growth in the Automotive Market





Various Automotive Electronics Solutions





Design and build in automotive —level quality and reliability

Comfort & Connectivity



Magnet (Dy-free)



NTC thermistor



Safety



TMR angle sensor







Antenna Coil LF Antenna

3D Antenna Coil







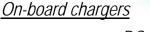
SAW/ thin film devices / modules



Contactless feed



Buzzer



DC-DC Converter



Wireless Charging System



Transformer



CeraLink

Power EMC Filter



PTC element



<u>Position sensor</u> <u>Gear-tooth sensor</u>



tooth sensor



ALU Capacitor Film Capacitor

Common mode filter





Inductor

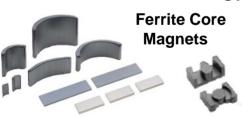
MLCC

Chip-varistor

Total Solution Provider to the Automotive Market



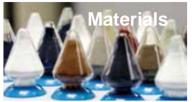
As a Total Solution Provider, TDK meets and exceeds customers' needs – from materials technology to electronic components, modules and testing services.

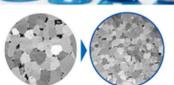












Materials

Total Solution provider

Evaluation

Devices

SAW/ thin film devices / modules











Modules/ Software









Support to meet Automotive EMC Standard "CISPR"

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